# DRAP127

Automotive grade high power density, shielded drum core power inductors



#### Product features

- AEC-Q200 qualified
- Secure four terminal mounting ideal for severe vibration environments up to 30 g.
- Rugged construction for high shock conditions
- Magnetically shielded-reduces EMI
- Inductance range from 0.41  $\mu H$  to 999  $\mu H$
- Current range from 0.6 A to 56 A
- 12.5 mm x 12.5 mm x 8.1 mm surface mount package
- Ferrite core material
- Weight: 4.46 grams typical
- Moisture Sensitivity Level: 1

#### Applications

- Body electronics
  - LED lighting (interior and exterior)
  - Central body control module
  - Vehicle access control module
  - Headlamps, tail lamps and interior lighting
  - Heating ventilation and air conditioning controllers (HVAC)
  - Doors, window lift and seat control
- Advanced driver assistance systems
  - Adaptive cruise control (ACC)
  - Automatic parking control
  - Collision avoidance system/ Car black box system
- · Infotainment and cluster electronics
  - Audio subsystem: head unit and trunk amp
  - · Digital instrument cluster
  - In-vehicle infotainment (IVI) and navigation
- Chassis and safety electronics
  - Electronic stability control system (ESC)
  - Electric parking brake
  - Electronic power steering (EPS) / Anti-locking braking system (ABS)
- Engine and powertrain systems
  - · Electric pumps, motor control and auxiliaries
  - Powertrain control module (PCU)/ Engine control unit (ECU)
  - Transmission control unit (TCU)

## Environmental compliance and general specifications

- Storage temperature range (Component): -40 °C to +165 °C
- Operating temperature range: -40 °C to +165 °C (ambient plus self-temperature rise)
- Solder reflow temperature: J-STD-020 (latest revision) compliant





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#### **Product specifications**

Part number <sup>6</sup>	OCL¹ (μΗ) ±20%	I <sup>2</sup> (A)	l <sub>sat</sub> 1 <sup>3</sup> (A)	I <sub>sat</sub> 2 <sup>4</sup> (A)	DCR (Ω) typical @ +25 °C	DCR (Ω) maximum @ +25 °C	K Factor⁵
DRAP127-R47-R	0.41	15.9	56	44.8	0.0024	0.0030	120
DRAP127-1R0-R	0.77	13.6	40	32	0.0034	0.0040	85.7
DRAP127-1R5-R	1.27	12.2	31	24.9	0.0043	0.0051	66.7
DRAP127-2R2-R	1.92	12.5	25.5	20.4	0.0040	0.0048	54.6
DRAP127-3R3-R	3.51	8.54	18.7	14.9	0.0086	0.0104	40
DRAP127-4R7-R	4.58	8.14	16.5	13.2	0.0094	0.011	35.3
DRAP127-6R8-R	6.72	6.52	13.3	10.7	0.015	0.018	28.6
DRAP127-8R2-R	8.33	6.33	12.2	9.74	0.016	0.019	26.1
DRAP127-100-R	9.63	6.02	11.2	8.96	0.017	0.021	24.0
DRAP127-150-R	14.90	4.83	9.03	7.23	0.027	0.032	19.4
DRAP127-220-R	21.5	3.98	7.57	6.05	0.040	0.047	16.2
DRAP127-330-R	32.0	3.22	6.22	4.98	0.060	0.072	13.3
DRAP127-470-R	47.9	2.62	5.09	4.07	0.091	0.110	10.9
DRAP127-680-R	68.2	2.33	4.18	3.34	0.115	0.138	9.0
DRAP127-820-R	83.9	2.01	3.84	3.07	0.155	0.186	8.2
DRAP127-101-R	101	1.89	3.46	2.77	0.175	0.210	7.4
DRAP127-151-R	151	1.52	2.83	2.26	0.269	0.320	6.1
DRAP127-221-R	220	1.25	2.35	1.88	0.398	0.480	5.0
DRAP127-331-R	328	1.01	1.93	1.54	0.612	0.730	4.1
DRAP127-471-R	475	0.827	1.62	1.29	0.910	1.10	3.5
DRAP127-681-R	677	0.736	1.33	1.06	1.15	1.39	2.8
DRAP127-821-R	825	0.637	1.22	0.978	1.54	1.85	2.6
DRAP127-102-R	999	0.598	1.10	0.878	1.75	2.10	2.4

1. Open circuit inductance (OCL) test parameters: 100 kHz, 0.25 Vrms, 0.0 Adc, +25 °C

2. I<sub>ms</sub>: DC current for an approximate temperature rise of 40 °C without core loss. Derating is necessary for AC currents. PCB layout, trace thickness and width, air-flow, and proximity of other heat generating components will affect the temperature rise. It is recommended that the temperature of the part not exceed +165 °C under worst case operating conditions verified in the end application.

3.  $I_{sat}$ 1: Peak current for approximately 30% rolloff @ +25 °C

4. I sat 2: Peak current for approximately 40% rolloff @ +125 °C

 K-factor: Used to determine Bp-p for core loss (see graph). Bp-p = K \* L \* ΔI. Bp-p:(Gauss), K: (K-factor from table), L: (Inductance in μH), ΔI (Peak-to-peak ripple current in Amps).

 Part Number Definition: DRAP127-xxx-R DRAP127= Product code and size xxx= Inductance value in µH, R= decimal point, If no R is present last character equals number of zeros

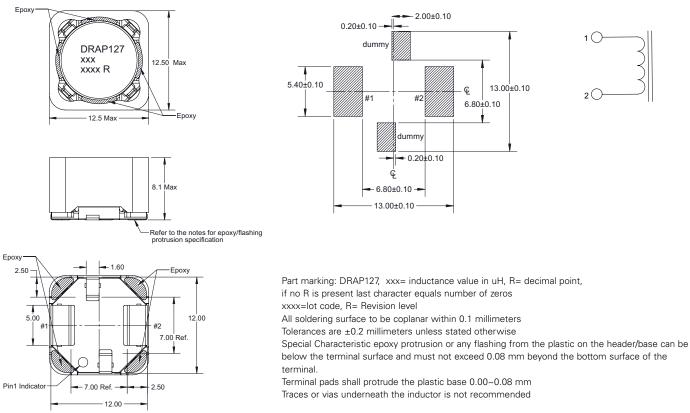
-R suffix = RoHS compliant

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#### **Dimensions (mm)**

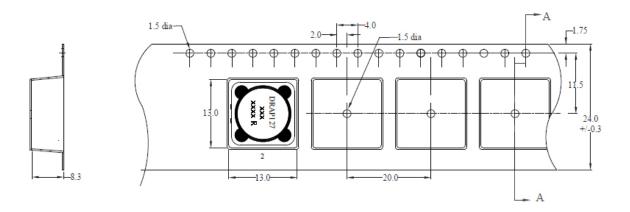




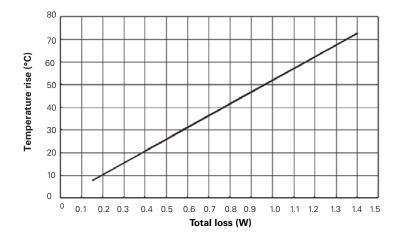


#### Packaging information (mm)

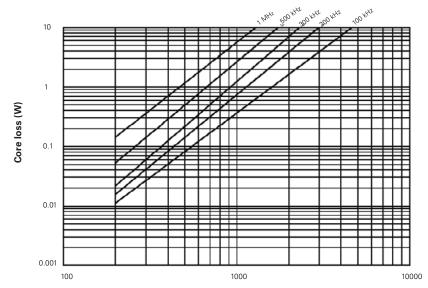
Supplied in tape and reel packaging , 350 parts per 13" diameter reel



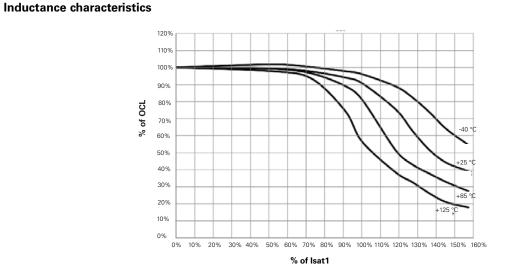
#### Temperature rise vs. total loss



#### Core loss vs. Bp-p

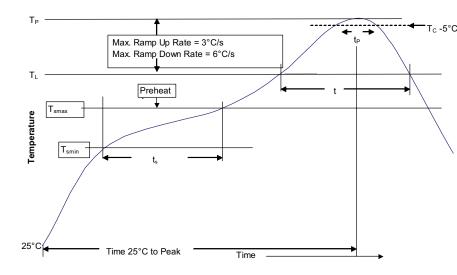


Bp-p (Gauss)



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#### Solder reflow profile



#### Table 1 - Standard SnPb solder $(T_c)$

Package thickness	Volume mm3 <350	Volume mm3 ≥350
<2.5 mm	235 °C	220 °C
≥2.5 mm	220 °C	220 °C

#### Table 2 - Lead (Pb) free solder (T<sub>c</sub>)

Pa th	ickage ickness	Volume mm <sup>3</sup> <350	Volume mm <sup>3</sup> 350 - 2000	Volume mm <sup>3</sup> >2000
<1	.6 mm	260 °C	260 °C	260 °C
1.6	6 – 2.5 mm	260 °C	250 °C	245 °C
>2	.5 mm	250 °C	245 °C	245 °C

#### **Reference J-STD-020**

Profile feature	Standard SnPb solder	Lead (Pb) free solder 150 °C	
Preheat and soak • Temperature min. (T <sub>smin</sub> )	100 °C		
• Temperature max. (T <sub>smax</sub> )	150 °C	200 °C	
• Time (T <sub>smin</sub> to T <sub>smax</sub> ) (t <sub>s</sub> )	60-120 seconds	60-120 seconds	
Ramp up rate TL to Tp	3 °C/ second max.	3 °C/ second max.	
Liquidous temperature (TL) Time (tL) maintained above TL	183 °C 60-150 seconds	217 °C 60-150 seconds	
Peak package body temperature (Tp)*	Table 1	Table 2	
Time $(t_p)^*$ within 5 °C of the specified classification temperature $(T_c)$	20 seconds*	30 seconds*	
Ramp-down rate (Tp to TL)	6 °C/ second max.	6 °C/ second max.	
Time 25 °C to peak temperature	6 minutes max.	8 minutes max.	

\* Tolerance for peak profile temperature (T<sub>p</sub>) is defined as a supplier minimum and a user maximum.

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